

# AN-1859 LP38512MR-ADJ Evaluation Board

# 1 Introduction

This board is designed to allow the evaluation of the LP38512MR-ADJ Voltage Regulator. Each board is assembled and tested in the factory. This evaluation board has the PSOP-8 package mounted, and the output voltage is set to 1.20V.

#### 2 General Description

The LP38512MR-ADJ is an adjustable LDO linear regulator capable of supplying up to 1.5A of output current, and incorporates an Enable function.

The device has been designed to work with 10  $\mu$ F input and output ceramic capacitors. Footprints areas for C<sub>IN</sub> and C<sub>OUT</sub> will allow for a variety of sizes.

#### 3 Operation

The input voltage, applied between  $V_{IN}$  and GND, should be at least 2.25V, or at least 500 mV greater than  $V_{OUT}$ , whichever value is larger. The input voltage should be no greater than 5.5V, which is the high end of the Operating Rating voltage.

Loads can be connected to  $V_{OUT}$  with reference to GND.

 $V_{OUT}$  and  $V_{IN}$  test points are provided on the board to allow accurate measurements directly onto the input and output pins of the device, eliminating any voltage drop on the PCB traces or connecting wires to the load.

# 4 Setting V<sub>out</sub>

The output voltage is set using the external resistive divider R1 and R2. The output voltage is given by the formula:

 $V_{OUT} = V_{ADJ} \times (1 + (R1 / R2))$ 

It is recommended that the values selected for R1 and R2 are such that the parallel value is less than 1.00 k $\Omega$ . This is to prevent internal parasitic capacitances on the ADJ pin from interfering with the F<sub>z</sub> pole set by R1 and C<sub>FF</sub>.

 $((R1 \times R2) / (R1 + R2)) \le 1.00 \text{ k}\Omega$ 

Table 1 lists some suggested, best fit, standard ±1% resistor values for R1 and R2, and a standard ±10% capacitor values for  $C_{FF}$ , for a range of  $V_{OUT}$  values. Other values of R1, R2, and  $C_{FF}$  are available that will give similar results.

Refer to AN-1378 Method for Calculating Output Voltage Tolerances in Adjustable Regulators Application Report (SNVA112) for additional information on how resistor tolerances affect the calculated  $V_{OUT}$  value.

The LP38512MR-ADJ Evaluation board is assembled with a 1.40 k $\Omega$  ±1% resistor for R1, and a 1.00 k $\Omega$  ±1% resistor for R2. This sets V<sub>OUT</sub> to 1.20V.

 $V_{OUT} = 500 \text{ mV} \times (1 + (1.40 \text{ k}\Omega / 1.00 \text{ k}\Omega))$ 

(3)

(1)

(2)

1

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V <sub>out</sub>	R1	R2	C <sub>FF</sub>	Fz
0.80V	1.07 kΩ	1.78 kΩ	4700 pF	31.6 kHz
1.00V	1.00 kΩ	1.00 kΩ	4700 pF	33.8 kHz
1.20V	1.40 kΩ	1.00 kΩ	3300 pF	34.4 kHz
1.50V	2.00 kΩ	1.00 kΩ	2700 pF	29.5 kHz
1.80V	2.94 kΩ	1.13 kΩ	1500 pF	36.1 kHz
2.00V	1.02 kΩ	340Ω	4700 pF	33.2 kHz
2.50V	1.02 kΩ	255Ω	4700 pF	33.2 kHz
3.00V	1.00 kΩ	200Ω	4700 pF	33.8 kHz
3.30V	2.00 kΩ	357Ω	2700 pF	29.5 kHz

# Table 1. Suggested Components

# 5 Selecting C<sub>FF</sub>

A capacitor placed across the gain resistor R1 will provide additional phase margin to improve load transient response of the device. This capacitor,  $C_{FF}$ , in parallel with R1, will form a zero in the loop response given by the formula:

 $F_{z} = (1 / (2 \times \pi \times C_{FF} \times R1))$ 

The value for  $C_{FF}$  should be selected to set a zero frequency ( $F_z$ ) between 25 kHz and 50 kHz using the formula:

 $C_{FF} = 1 / (2 \times \pi \times F_z \times R1)$ 

4

2

0

20

10

0

-10

-20

l<sub>out</sub> (A)

ΔV<sub>OUT</sub> (mV)

2

The closest standard 10% value is usually adequate for C<sub>FF</sub>.

∖1.′5A

R1=1.4ὑ kΩ, R2=1.ὑ0 kΏ, Ċ<sub>FF</sub>=330ὑ pF

10 µs/DIV

.10 mÁ

The LP38512MR-ADJ Evaluation board is assembled with a 3300 pF capacitor for  $C_{FF}$ . This sets  $F_z$  to approximately 34 kHz.

 $F_z = (1 / (2 \times \pi \times 3300 \text{ pF} \times 1.40 \text{k}\Omega)) = 34.4 \text{ kHz}$ 







(6)

(4)

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#### 6 Enable Function

ON/OFF control is provided by supplying a logic level signal to the Enable pin. A minimum  $V_{EN}$  value of 1.2V is typically required at this pin to enable the LDO output. The LDO output will be shutdown when the  $V_{EN}$  value is typically 0.6V or less. The  $V_{EN}$  threshold incorporates approximately 100 mV of hysteresis.

In applications where the LP38512MR-ADJ is operated continuously the Enable pin can be connected directly to  $V_{IN}$ . The Enable pin has no default bias and must not be left floating. The Enable pin must be actively driven to the appropriate voltage level.



# 7 Power Dissipation

The PSOP-8 package alone has a junction to ambient thermal resistance ( $\theta_{JA}$ ) rating of 168°C/W when mounted to the minimum land area (EIA/JESD51-3). When mounted on the LP38512MR-ADJ Evaluation Board the  $\theta_{JA}$  rating is approximately 40°C/W.

The exposed DAP is soldered to the copper area immediately under the package. The top copper surface area is extended to additional copper area on the bottom of the board by five thermal vias placed inside the DAP land area.

With the 40°C/W thermal rating the LP38512MR-ADJ evaluation board will dissipate a maximum of 2.5W with  $T_A = 25^{\circ}C$ .





Enable Function



Pin Out

# 8 Pin Out





#### 9 Schematic Diagram





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# 10 Bill of Materials

ID	Name	Description	Manufacturer	Part Number
PCB	PCB	Printed Circuit Board	Texas Instruments	600174
U1	U1	LP38512	Texas Instruments	LP38512
C1	C <sub>IN</sub>	Capacitor: 10 μF; ±10%; MLCC; 10V; X7R; 1210		
C2	C <sub>OUT</sub>	Capacitor: 10 µF;, ±10%; MLCC; 10V; X7R; 1210		1210ZC106KAT2A
C3	C <sub>FF</sub>	Capacitor: 3300 pF;, ±10%; MLCC; 50V; X7R; 0805 KEMET		C0805C332K5RAC
J1	V <sub>EN</sub>	Banana Jack : Insulated Solder Terminal; White		108-0901-001
J2	V <sub>IN</sub>	Banana Jack : Insulated Solder Terminal; Red	Johnson Componente	108-0902-001
J3	GND	Banana Jack : Insulated Solder Terminal; Black	Johnson Components	108-0903-001
J4	V <sub>OUT</sub>	Banana Jack : Insulated Solder Terminal; Orange		108-0906-001
R1	R1	Resistor: 1.40 kΩ, ±1%; Thick Film; 125 mW; ±100 ppm; 0805		CRCW08051K40FK
R2	R2	Resistor: 1.00 kΩ, ±1%; Thick Film; 125 mW; ±100 ppm; 0805	VISHAY DALE	CRCW08051K00FK
R3	R3	Resistor: 10.0 kΩ, ±1%; Thick Film; 125 mW; ±100 ppm; 0805		CRCW080510K0FK
TP1				
TP2		Turret Terminal : Mounting Hole	Keystone	1593–2
TP3		Diameter = 0.062"		
TP4	TP <sub>OUT</sub>			

#### Table 2. Bill of Materials

Bill of Materials



PCB Layout

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## 11 PCB Layout



Figure 8. Evaluation Board Component and Pin Layout

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Figure 9. Top Side Copper Area



Figure 10. Bottom Side Copper Area

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